

nCELL-T5000

5G Virtualized Units

5GNR 4 Cells 3GPP Release 15/R16* DL 1.5Gbps/UL 260Mbps 400 Active Users per cell

The nCELL-T5000 from BTI WIRELESS is used to realize 5G NR base station processing unit to centrally control and manage the entire base station system. It realizes direct access and data interaction with 5G core network, with NGAP and XnAP interface. Also, the product realizes 5G NR access network protocol stack function, RRC, PDCP, SDAP, RLC, MAC and PHY protocol layer functions, as well as baseband processing functions.



PROCESSOR PARAMETERS	
CPU	CPU Intel [®] Xeon [®] D-2177NT Processor 105W (14C/28T)
	CPU Intel [®] Xeon [®] D-2187NT Processor 110W (16C/32T)
Photolithography	14nm
Processor Base Frequency	XeonD-2177NT Processor – 1.9GHz
Flotessol base flequency	XeonD-2187NT Processor – 2.0GHz
Maximum Turbo Frequency	3.00 GHz
Cache	19 MB
Memory Type	DDR4-2666
Supported ECC Memory	Yes
Maximum Number of Memory	4
Channels	
Maximum Memory Speed	2667 MHz
Maximum Memory	256 GB
(Depending on Memory Type)	230 00
Chipset	Intel [®] Xeon [®] SoC
Size	482.6 x 420 x 44.5 mm 19.00 x 16.54 x 1.75 in
Weight	6.5 kg 14.33 lbs
	450W 1+1 redundant PSUs
Power Supply	100V to 240V AC @50-60Hz
	-36V to -72V DC
MTBF	150,000 h

FUNCTIONAL INDICATORS		
Standard	3GPP R15/R16*	
	Xeon D-2177NT Processor	
	Xeon D-2187NT Processor	
Maximum Number of Cells	2 (XeonD-2177NT Processor)	
Maximum Number of Cells	4 (XeonD-2187NT Processor)	
Carrier Bandwidth	20MHz/40MHz/50MHz/60MHz/80MHz/100 MHz	
Subcarrier Spacing	30 kHz	
Number of Active Users	400 users	
Downlink Peak Rate	1.5 Gbps (DDDSU), 658Mbps (DSUUU)	
Uplink Peak Rate	260 Mbps (DDDSU), 669Mbps (DSUUU)	
Maximum Number of Data Streams	Downlink 4 streams	
Maximum Number of Data Streams	Uplink 2 streams	
Number of Concurrently Scheduled Users	4 users / Slot	



RF Front End	RRU with FPGA/DSP
RF Front End	< 6 GHz
Duplex Mode	TDD, FDD
BS Spatial Layers	4
UE Spatial Layers	2
Fronthaul Bandwidth	10G
Number of Fronthaul Interfaces	4
Return Bandwidth	10G
Number of Return Interfaces	2
Note:"*"means it is on roadmap.	

ENVIRONMENTAL SPECIFICATIONS			
Temperature	Operation	-5 °C ~ +55 °C +23 °F ~ +131 °F	
	Storage	-40 °C ~ +70 °C -40 °F ~ +158 °F	
Lives alter	Operation	10% ~ 85% RH @40 °C, non-condensing	
Humidity	Storage	5% ~ 90% RH, non-condensing	
Fan	6 fans, adaptive speed		
Shock	Operating time: Half sine 2G, 11ms pulse, 100 pulses in each direction		
	Non-operating: Trapezoid, 25G, 170 inches/sec DeltaV, 3 drop tests in each direction		
Vibration	Non-operating time: 2.2Grms, 10 minutes per axis per direction		
Decibel	Sound pressure < 75 dBA @1m, all fans run at maximum speed		

DEVICE INTERFACE

LEDs: Power, Alert, Drive Activity. 2x RJ-45 100/1000BASE-T Ethernet port 1x F	LEDs: UID, BMC Heartbeat 2x USB 3.0 2x JSB 3.0 2x RJ-45 1PPS/TOD Port 4x 10G SFP+ Ethenet Port	
	2 x RJ-45 100/ 1000BASE-T Ethernet port	
	4 x 10G SFP+ Ethernet port	
IO Interface	2 x RJ-45 1PPS/ TOD port	
	1 x RJ-45 console port	
	2 x USB 3.0	
Pack Interface	1 x VGA rear	
Dack Interface	1 x Power Plug	



INTERNAL INTERFACE	
IO Interface	1 x USB 2.0
	1 x COM
	4 x 1PPS SMA input/ output
PCIe	2 x PCIe x16 Gen3 single-slot FHFL interfaces, up to 110W each
	Or
	1 x PCIe x16 Gen3 single-slot FHFL interface, up to 250W
	1 x PCle x8 Gen3 OCP NIC v2
	2 x 2.5" hot-swappable SATA 6 Gb/s
Storage	1 x onboard M.2 NVME socket, 2242 M Key
	1 x onboard M.2 NVME socket, 2280 M Key



FGAF Acceleration Card

5G Virtualized Units

5G ORAN Prequel 5G Baseband Processing Acceleration 10G Ethernet 1588V2 Clock Synchronization Service

The integrated fronthaul accelerator card FGAF uses Xilinx's Zynq Ultra Scale+ MPSOC and Kintex Ultra Scale+ FPGA to realize the functions of baseband processing acceleration and data forwarding, and meets the application requirements of high bandwidth, low latency and multi-cell deployment required by the 5G BBU system. Very high integration and ease of use.

This card is a single-slot, full-height half-length (FHHL) card, using PCleGen3x16 interface (supports bifurcation into two sets of Gen3x8 interfaces) to connect to the system, and externally supports 4 SFP+ optical ports.

The card is equipped with a high-precision clock source and clock phase-lock circuit, supports external 1588V2 and GPS input, and can provide stable clock synchronization services to the next-level network node through the SFP+ fronthaul interface.



BASEBAND PROCESSING ACCELERATION PERFORMANCE			
	Throughput Rate	Delay	
LDPC Encoding	17.8 Gbps	14µs	
LDPC Decoding	8.1 Gbps	16µs	

FRONTHAUL DATA FORWARDING PERFORMANCE			
	Downlink Rate	Uplink Rate	Remarks
Single optical port rate	10 Gbps	10 Gbps	Full package mode, 4 concurrent ports
Single optical port rate	9 Gbps	9 Gbps	Burst32, large and small packet interval mode, 4 concurrent ports

CLOCK SYNCHRONIZATION PERFORMANCE			
Support Standard	Index	Uplink Rate	
Grand master	Support clock synchronization of 128 nodes	Number of Slavers	
SyncE G.8262	All 4 interfaces support		
Keep ability	1.5µs over 8 Hours	Choose high stability OCXO	







SINGLE BOARD SPECIFICATIONS				
Physical layer acceleration	LDPC codec	Codec encapsulation logic, supports CRC, rate matching and de- rate matching		
Fronthaul	4x10G eCPRI Supports 1588V2	Data aggregation	Data cache	Package classification management
Clock circuit	Onboard OCXO, high- precision phase-locked loop synchronization circuit	Onboard GPS receiver module	Supports external 1588V2 input	

CHIPSET SPECIFICATIONS			
Chin Madal	Xilinx Zynq Ultra Scale Plus RFSoC XCZU21DR		
	Xilinx Kintex Ultra Scale+ XCKU3P		
	XCZU21DR	ХСКИЗР	
System Resource	• System Logic cells - 930K	• System Logic cells - 365K	
	• CLB LUT - 425K	• CLB LUT - 163K	
	• SDFEC -8	• DSP Slices - 1,368	
	• DSP Slices - 4,272	• BRAM - 12.7Mb	
	• BRAM - 38.0Mb	• URAM - 13.5Mb	
	• URAM - 22.5Mb	• GTY Transceivers - 16	
	Full-height, half-length (FHHL)		
Structure Size	x16 PCIe form factor		
	W x H x D: 169.6 x 110.6 mm x 18.6 mm 6.68 x 4.35 x 0.73 in		
PCIe Interface	PCIe Gen3 x16 interface bifurcated to two PCIe Gen3 x8		
	• 2xBanks of 512M x 48 –PL		
Onhoard PAM Pasources	• 1xBank of 512Mx 32 – PS		
Onboard RAW Resources	• Total Capacity 6GB in PL	7	
	• Total Capacity 2GB in PS		
Onboard FLASH Resources	1Gb SPI FLASH NOR SLC	256Mb SPI FLASH NOR SLC	
Network Interface	4 SFP+ optical ports		
Cooling Method	Module with cooling teeth, cooling through internal air ducts in the case		
	Single board power-up sequence management and hot reset and shutdown		
Single Board	functions		
Management	Supports local software upgrade		
	• JTAG daisy-chaining design to support burning and debugging of two devices		



	 On-board RS232 debug port On-board Ethernet debug port 	
Single Board Working Temperature	0 °C ~ +80 °C +32 °F ~ +176 °F	
Single Board Power Consumption	< 35W	
Single Board Clock Synchronization Mode	 Supports external GPS antenna for GPS synchronization Supports 1588V2 time information input via external Ethernet RJ45 Optional high stability crystal oscillator for local clock keeping within 8 hours with time accuracy deviation less than ±1.5µs 	

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